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ON Semiconductor® ISL9V5036S3S / ISL9V5036P3 / ISL9V5036S3

EcoSPARK® 500mJ, 360V, N-Channel Ignition IGBT

General Description

Applications

Automotive Ignition Coil Driver CircuitsCoil-On Plug Applications

The ISL9V5036S3S, ISL9V5036P3, and ISL9V5036S3 are the next generation IGBTs that offer outstanding SCIS capability in the D²-Pak (TO-263) and TO-220 plastic package. These devices are intended for use in automotive ignition circuits, specifically as coil drivers. Internal diodes provide voltage clamping without the need for external components.

EcoSPARK® devices can be custom made to specific clamp voltages. Contact your nearest ON Semiconductor sales office for more information.

Features

- Industry Standard D²-Pak package
- SCIS Energy = 500mJ at $T_J = 25^{\circ}C$
- Logic Level Gate Drive
- Qualified to AEC Q101
- RoHS Compliant

Formerly Developmental Type 49443



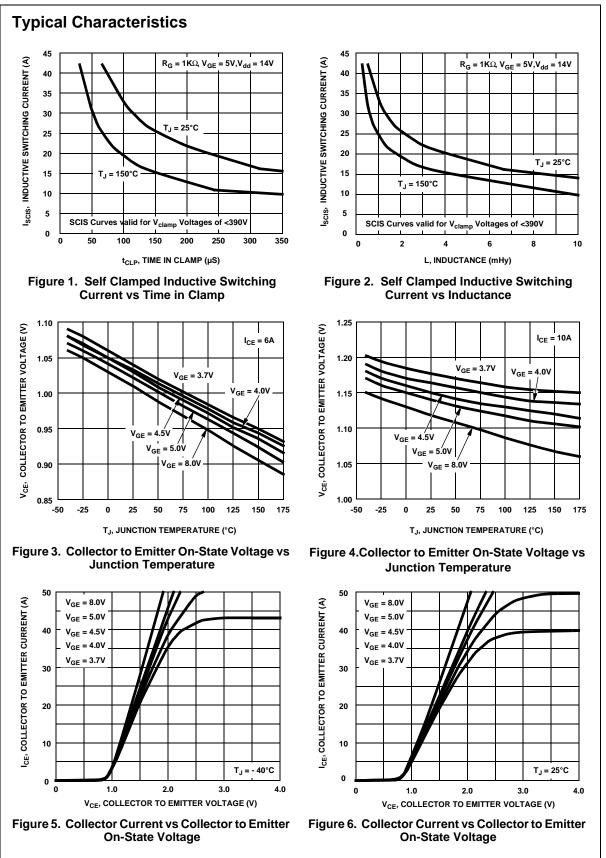
Package Symbol COLLECTOR JEDEC TO-263AB JEDEC TO-262AA JEDEC TO-220AB ^Ec_G D²-Pak ^Ес_б GATE R, Е COLLECTOR COLLECTOR (FLANGE) (FLANGE)

Device Maximum Ratings T_A = 25°C unless otherwise noted

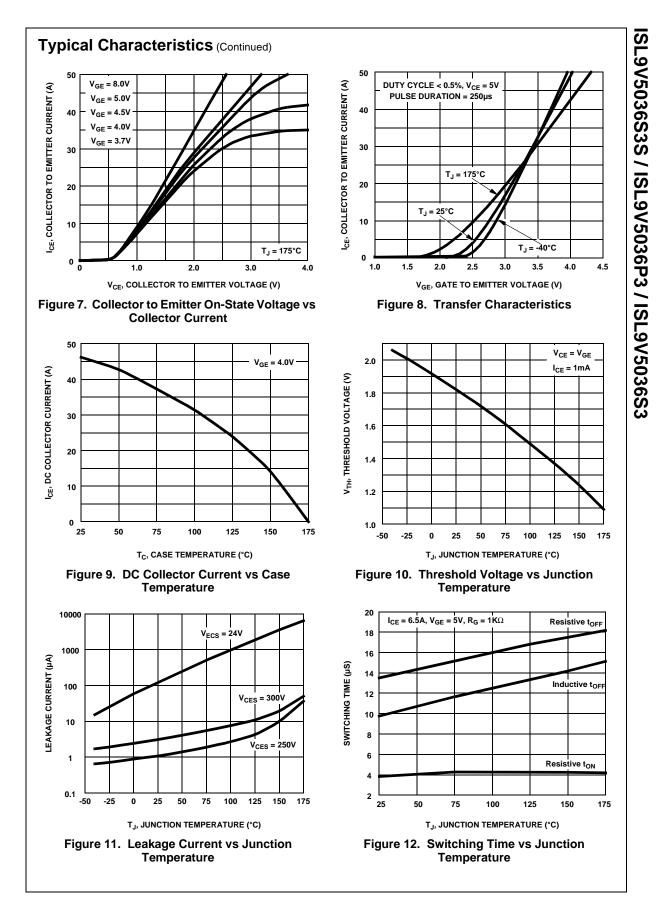
| Symbol | Parameter | Ratings | Units |
|----------------------|---|------------|-------|
| BV _{CER} | Collector to Emitter Breakdown Voltage (I _C = 1 mA) | 390 | V |
| BV _{ECS} | Emitter to Collector Voltage - Reverse Battery Condition (I _C = 10 mA) | 24 | V |
| E _{SCIS25} | At Starting $T_J = 25^{\circ}$ C, $I_{SCIS} = 38.5$ A, L = 670 μ Hy | 500 | mJ |
| E _{SCIS150} | At Starting $T_J = 150^{\circ}$ C, $I_{SCIS} = 30$ A, $L = 670 \mu$ Hy | 300 | mJ |
| I _{C25} | Collector Current Continuous, At T _C = 25°C, See Fig 9 | 46 | Α |
| I _{C110} | Collector Current Continuous, At T _C = 110°C, See Fig 9 | 31 | Α |
| V _{GEM} | Gate to Emitter Voltage Continuous | ±10 | V |
| PD | Power Dissipation Total $T_C = 25^{\circ}C$ | 250 | W |
| | Power Dissipation Derating $T_{C} > 25^{\circ}C$ | 1.67 | W/°C |
| ТJ | Operating Junction Temperature Range | -40 to 175 | °C |
| T _{STG} | Storage Junction Temperature Range | -40 to 175 | °C |
| ΤL | Max Lead Temp for Soldering (Leads at 1.6mm from Case for 10s) | 300 | °C |
| T _{pkg} | Max Lead Temp for Soldering (Package Body for 10s) | 260 | °C |
| ESD | Electrostatic Discharge Voltage at 100pF, 1500 Ω | 4 | kV |

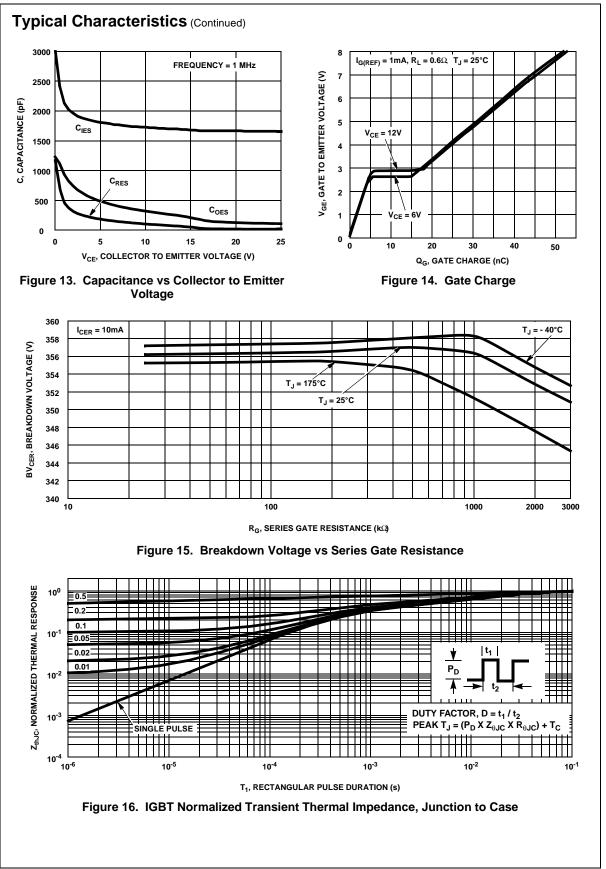
| Device Marking | | g Device | | Package | Reel Size | e | Tape Wic | lth | Quantity |
|--|---|--|--------------------------------------|--|--|--|--|---|--|
| V5036S | | ISL9V5036S3ST | | TO-263AB | 330mm | | 24mm | | 800 |
| V50 | 36P | ISL9V5036P3 | | TO-220AA | Tube | | N/A | | 50 |
| V5036S | | ISL9V5036S3 | | TO-262AA | Tube | N/A | | | 50 |
| V5036S | | ISL9V5036S3S | | TO-263AB Tube | | | N/A | | 50 |
| | al Char | acteristics T _A = 25 | 5°C un | less otherwise n | oted | | | | |
| Symbol | | Parameter | | Test Con | 1 | Min | Тур | Мах | Units |
| f State | Characte | eristics | | | | | | | |
| BV _{CER} | Collector | to Emitter Breakdown Vo | ltage | I _C = 2mA, V _{GE} = R _G = 1KΩ, See T _J = -40 to 150° | e Fig. 15 | 330 | 360 | 390 | V |
| BV _{CES} | Collector | Collector to Emitter Breakdown Voltage | | $I_{C} = 10mA, V_{GE} = 0,$ $R_{G} = 0, See Fig. 15$ $T_{J} = -40 \text{ to } 150^{\circ}\text{C}$ | | 360 | 390 | 420 | V |
| BV _{ECS} | Emitter to | Collector Breakdown Vo | oltage | $I_{C} = -75$ mA, $V_{GE} = 0$ V, $T_{C} = 25$ °C | | 30 | - | - | V |
| BV_{GES} | Gate to E | mitter Breakdown Voltag | е | $I_{GES} = \pm 2mA$ | | ±12 | ±14 | - | V |
| I _{CER} | Collector | to Emitter Leakage Curre | ent | $V_{CER} = 250V,$ | $T_{C} = 25^{\circ}C$ | - | | 25 | μA |
| | | | | R _G = 1KΩ See Fig. 11 | T _C = 150°C | - | - | 1 | mA |
| I _{ECS} | Emitter to | Collector Leakage Curre | Emitter to Collector Leakage Current | | $T_{C} = 25^{\circ}C$ | - | - | 1 | mA |
| | 1 | | | | | | - | 10 | mA |
| | - | | | Fig. 11 | T _C = 150°C | - | | 40 | |
| R ₁ R ₂ | | ite Resistance mitter Resistance | | Fig. 11 | 1 _C = 150°C | - - 10K | - 75 | 40 - 30K | Ω Ω |
| R ₂ | Gate to E | mitter Resistance | tage | | $T_{\rm C} = 150^{\circ}{\rm C}$ $T_{\rm C} = 25^{\circ}{\rm C},$ See Fig. 4 | - | 75 | - | Ω |
| R ₂ | Gate to El | mitter Resistance | - | I _C = 10A, | T _C = 25°C, | - | 75 | - 30K | Ω Ω V |
| R ₂ n State (V _{CE(SAT)} | Gate to El | mitter Resistance eristics to Emitter Saturation Vol to Emitter Saturation Vol | - | I _C = 10A, V _{GE} = 4.0V I _C = 15A, | T _C = 25°C, See Fig. 4 | - 10K - | 75 - 1.17 | - 30K 1.60 | Ω Ω V |
| R2 n State VCE(SAT) VCE(SAT) /namic QG(ON) | Gate to E | mitter Resistance eristics to Emitter Saturation Vol to Emitter Saturation Vol eristics | - | $I_{C} = 10A, V_{GE} = 4.0V$ $I_{C} = 15A, V_{GE} = 4.5V$ $I_{C} = 10A, V_{CE} = V_{GE} = 5V, See$ | $T_{C} = 25^{\circ}C,$ See Fig. 4 $T_{C} = 150^{\circ}C$ 12V, Fig. 14 | - 10K - | 75 - 1.17 | - 30K 1.60 | Ω Ω V |
| R ₂ n State (V _{CE(SAT)} V _{CE(SAT)} | Gate to Ei | mitter Resistance eristics to Emitter Saturation Vol to Emitter Saturation Vol eristics | tage | $I_{C} = 10A, V_{GE} = 4.0V$ $I_{C} = 15A, V_{GE} = 4.5V$ $I_{C} = 10A, V_{CE} = V_{GE} = 5V, See$ $I_{C} = 1.0mA,$ | $T_{C} = 25^{\circ}C,$ See Fig. 4 $T_{C} = 150^{\circ}C$ = 12V, Fig. 14 $T_{C} = 25^{\circ}C$ | - 10K - | 75 - 1.17 1.50 | - 30K 1.60 | Ω Ω Ω V V |
| R_{2} n State (VCE(SAT)) $VCE(SAT)$ $VCE(SAT)$ $Q_{G(ON)}$ $V_{GE(TH)}$ | Gate to Ei Characte Collector f Collector f Characte Gate Cha Gate to E | mitter Resistance eristics to Emitter Saturation Vol to Emitter Saturation Vol eristics rge mitter Threshold Voltage | tage | $I_{C} = 10A, V_{GE} = 4.0V$ $I_{C} = 15A, V_{GE} = 4.5V$ $I_{C} = 10A, V_{CE} = V_{GE} = 5V, See I$ $I_{C} = 1.0MA, V_{CE} = V_{GE}, See Fig. 10$ | $T_{C} = 25^{\circ}C,$ See Fig. 4 $T_{C} = 150^{\circ}C$ = 12V, = 12V, = 12V, = 12V, = 150^{\circ}C $T_{C} = 25^{\circ}C$ $T_{C} = 150^{\circ}C$ | - 10K - - 1.3 0.75 | 75 - 1.17 1.50 32 - - | - 30K 1.60 1.80 - - 2.2 1.8 | Ω Ω Ω V V nC V V |
| R2 n State VCE(SAT) VCE(SAT) /namic QG(ON) | Gate to Ei Characte Collector f Collector f Characte Gate Cha Gate to E | mitter Resistance eristics to Emitter Saturation Vol to Emitter Saturation Vol eristics rge | tage | $I_{C} = 10A, V_{GE} = 4.0V$ $I_{C} = 15A, V_{GE} = 4.5V$ $I_{C} = 10A, V_{CE} = V_{GE} = 5V, See$ $I_{C} = 1.0mA, V_{CE} = V_{GE}, V_{CE} = V_{GE}, V_{CE} = V_{GE}, V_{CE} = V_{CE}, V_{CE}, V_{CE} = V_{CE}, V_{CE} = V_{CE}, V_{CE} = V_{CE}, V$ | $T_{C} = 25^{\circ}C,$ See Fig. 4 $T_{C} = 150^{\circ}C$ = 12V, Fig. 14 $T_{C} = 25^{\circ}C$ | - 10K - - - 1.3 | 75 - 1.17 1.50 32 | - 30K 1.60 1.80 | Ω Ω V V V |
| R2 n State VCE(SAT) VCE(SAT) VCE(SAT) VGE(SAT) VGE(ON) VGE(TH) VGEP | Gate to Ei Characte Collector f Collector f Characte Gate Cha Gate to E | mitter Resistance eristics to Emitter Saturation Vol to Emitter Saturation Vol eristics rge mitter Threshold Voltage | tage | $I_{C} = 10A, V_{GE} = 4.0V$ $I_{C} = 15A, V_{GE} = 4.5V$ $I_{C} = 10A, V_{CE} = V_{GE} = 5V, See I$ $I_{C} = 1.0MA, V_{CE} = V_{GE}, See Fig. 10$ | $T_{C} = 25^{\circ}C,$ See Fig. 4 $T_{C} = 150^{\circ}C$ = 12V, = 12V, = 12V, = 12V, = 150^{\circ}C $T_{C} = 25^{\circ}C$ $T_{C} = 150^{\circ}C$ | - 10K - - 1.3 0.75 | 75 - 1.17 1.50 32 - - | - 30K 1.60 1.80 - - 2.2 1.8 | Ω Ω Ω V V nC V V |
| R2 n State VCE(SAT) VCE(SAT) VCE(SAT) VGE(SAT) VGE(ON) VGE(TH) VGEP | Gate to Ei Characte Collector f Collector f Characte Gate Cha Gate to E Gate to E Charact | mitter Resistance eristics to Emitter Saturation Vol to Emitter Saturation Vol eristics rge mitter Threshold Voltage | tage | $I_{C} = 10A, V_{GE} = 4.0V$ $I_{C} = 15A, V_{GE} = 4.5V$ $I_{C} = 10A, V_{CE} = V_{GE} = 5V, See I$ $I_{C} = 1.0MA, V_{CE} = V_{GE}, See Fig. 10$ | $T_{C} = 25^{\circ}C$, See Fig. 4 $T_{C} = 150^{\circ}C$ Fig. 14 $T_{C} = 25^{\circ}C$ $T_{C} = 150^{\circ}C$ $V_{CE} = 12V$ | - 10K - - 1.3 0.75 | 75 - 1.17 1.50 32 - - | - 30K 1.60 1.80 - - 2.2 1.8 | Ω Ω Ω V V nC V V |
| R ₂ n State (V _{CE(SAT)} V _{CE(SAT)} (Namic (Q _{G(ON)}) V _{GE(TH)} V _{GEP} | Gate to Ei Characte Collector f Collector f Characte Gate Cha Gate to E Gate to E Gate to E Charact | mitter Resistance eristics to Emitter Saturation Vol to Emitter Saturation Vol eristics rge mitter Threshold Voltage mitter Plateau Voltage teristics | tage | $I_{C} = 10A, V_{GE} = 4.0V$ $I_{C} = 15A, V_{GE} = 4.5V$ $I_{C} = 10A, V_{CE} = V_{GE} = 5V, See I$ $I_{C} = 1.0mA, V_{CE} = V_{GE}, See Fig. 10$ $I_{C} = 10A,$ | $T_{C} = 25^{\circ}C$, See Fig. 4 $T_{C} = 150^{\circ}C$ Fig. 14 $T_{C} = 25^{\circ}C$ $T_{C} = 150^{\circ}C$ $V_{CE} = 12V$ = 1Ω 1KΩ | - - - 1.3 0.75 - | 75 - 1.17 1.50 32 - - 3.0 | - 30K 1.60 1.80 - 2.2 1.8 - | Ω Ω Ω V V NC V V V V V |
| R_2 n State of VCE(SAT) VCE(SAT) VCE(SAT) VCE(SAT) VGE(ON) VGE(TH) VGEP vitching t _{d(ON)R} | Gate to Ei Characte Collector f Collector f Collector f Characte Gate Cha Gate to E Gate to E Charact Current Ti Current R | mitter Resistance eristics to Emitter Saturation Vol to Emitter Saturation Vol eristics rge mitter Threshold Voltage mitter Plateau Voltage teristics urn-On Delay Time-Resi | stive | $I_{C} = 10A, V_{GE} = 4.0V$ $I_{C} = 15A, V_{GE} = 4.5V$ $I_{C} = 10A, V_{CE} = V_{GE} = 5V, See I$ $I_{C} = 1.0mA, V_{CE} = V_{GE}, See Fig. 10$ $I_{C} = 10A,$ $V_{CE} = 14V, R_{L} = V_{GE} = 5V, R_{G} = T_{J} = 25^{\circ}C, See$ $V_{CE} = 300V, L = 100$ | $T_{C} = 25^{\circ}C,$ See Fig. 4 $T_{C} = 150^{\circ}C$ Fig. 14 $T_{C} = 25^{\circ}C$ $T_{C} = 150^{\circ}C$ $V_{CE} = 12V$ = 1Ω 1KΩ Fig. 12 = 2mH, | - - - 1.3 0.75 - | 75 - 1.17 1.50 32 - 3.0 0.7 | - 30K 1.60 1.80 - 2.2 1.8 - - | Ω Ω Ω V V NC V V V V V V V V V V V V V V V μs |
| $\begin{array}{c} R_2 \\ \hline R_2 \\ \hline$ | Gate to Ei Characte Collector f Collector f Collector f Characte Gate Cha Gate to E Gate to E Gate to E Charact Current Ti Current Ti Current Ti Current Ti | mitter Resistance eristics to Emitter Saturation Vol- to Emitter Saturation Vol- to Emitter Saturation Vol- eristics rge mitter Threshold Voltage mitter Plateau Voltage teristics urn-On Delay Time-Resis- ise Time-Resistive urn-Off Delay Time-Induc- all Time-Inductive | stive | $\label{eq:constraint} \begin{array}{c} I_{C} = 10A, \\ V_{GE} = 4.0V \\ I_{C} = 15A, \\ V_{GE} = 15A, \\ V_{GE} = 5V, See \\ I_{C} = 1.0mA, \\ V_{CE} = V_{GE}, \\ See \\ Fig. 10 \\ I_{C} = 10A, \\ \end{array}$ | $T_{C} = 25^{\circ}C,$ See Fig. 4 $T_{C} = 150^{\circ}C$ Fig. 14 $T_{C} = 25^{\circ}C$ $T_{C} = 150^{\circ}C$ $V_{CE} = 12V$ V _{CE} = 12V = 1Ω, 1KΩ Fig. 12 = 2mH, 1KΩ Fig. 12 | - 10K - - 1.3 0.75 - - | 75 - 1.17 1.50 32 - 3.0 0.7 2.1 | - 30K 1.60 1.80 - 2.2 1.8 - - 4 7 | Ω Ω Ω V V NC V V V V V V V V V V V V V V V μs |
| R_{2} n State of VCE(SAT) VCE(SAT) VCE(SAT) VCE(SAT) VGE(ON) VGE(TH) VGEP vitching t _{d(ON)R} t _{rR} t _{d(OFF)L} | Gate to Ei Characte Collector f Collector f Collector f Characte Gate Cha Gate to E Gate to E Gate to E Charact Current Ti Current Ti Current Ti Current Ti | mitter Resistance eristics to Emitter Saturation Vol to Emitter Saturation Vol eristics rge mitter Threshold Voltage mitter Plateau Voltage teristics urn-On Delay Time-Resi ise Time-Resistive urn-Off Delay Time-Indu | stive | $\label{eq:constraint} \begin{array}{c} I_{C} = 10A, \\ V_{GE} = 4.0V \\ I_{C} = 15A, \\ V_{GE} = 4.5V \\ \end{array} \\ \begin{array}{c} I_{C} = 10A, \\ V_{CE} = V_{GE}, \\ See \\ Fig. 10 \\ I_{C} = 10A, \\ \end{array} \\ \begin{array}{c} V_{CE} = 14V, \\ V_{CE} = V_{GE}, \\ See \\ Fig. 10 \\ I_{C} = 10A, \\ \end{array} \\ \begin{array}{c} V_{CE} = 14V, \\ V_{CE} = 5V, \\ See \\ V_{CE} = 5V, \\ R_{G} = \\ \end{array} \\ \begin{array}{c} V_{CE} = 300V, \\ L = \\ V_{GE} = 5V, \\ R_{G} = \\ \end{array} \\ \end{array}$ | $T_{C} = 25^{\circ}C,$ See Fig. 4 $T_{C} = 150^{\circ}C$ Fig. 14 $T_{C} = 25^{\circ}C$ $T_{C} = 150^{\circ}C$ $V_{CE} = 12V$ $V_{CE} = 12V$ = 1Ω, 1KΩ Fig. 12 = 2mH, 1KΩ Fig. 12 = 2mH, 1KΩ Fig. 12 = 370 µH, | - - - - 1.3 0.75 - - - | 75 - 1.17 1.50 32 - 3.0 0.7 2.1 10.8 | - 30K 1.60 1.80 - 2.2 1.8 - - - 2.2 1.8 - - - - - - - - - - - - - - - - - - - | Ω Ω Ω V V NC V |

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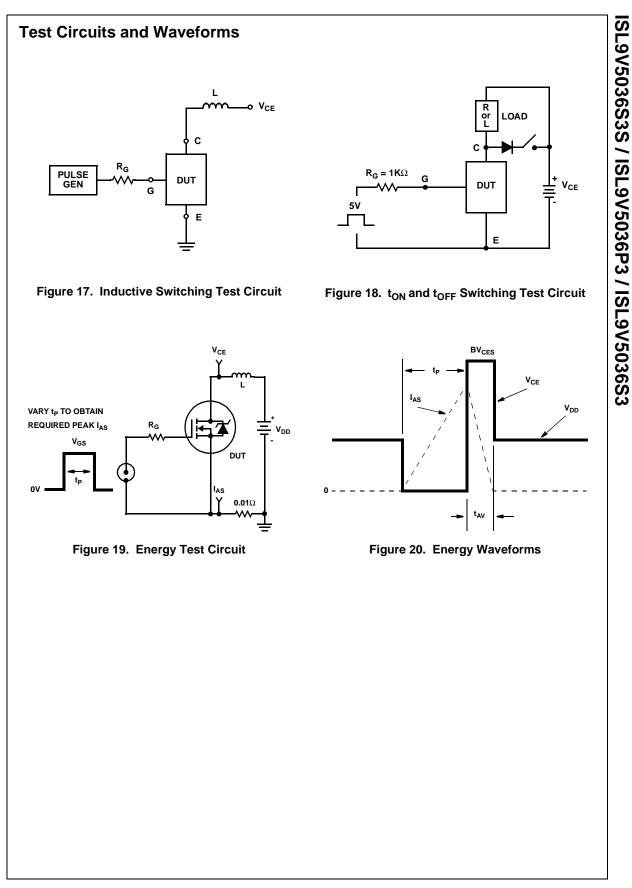


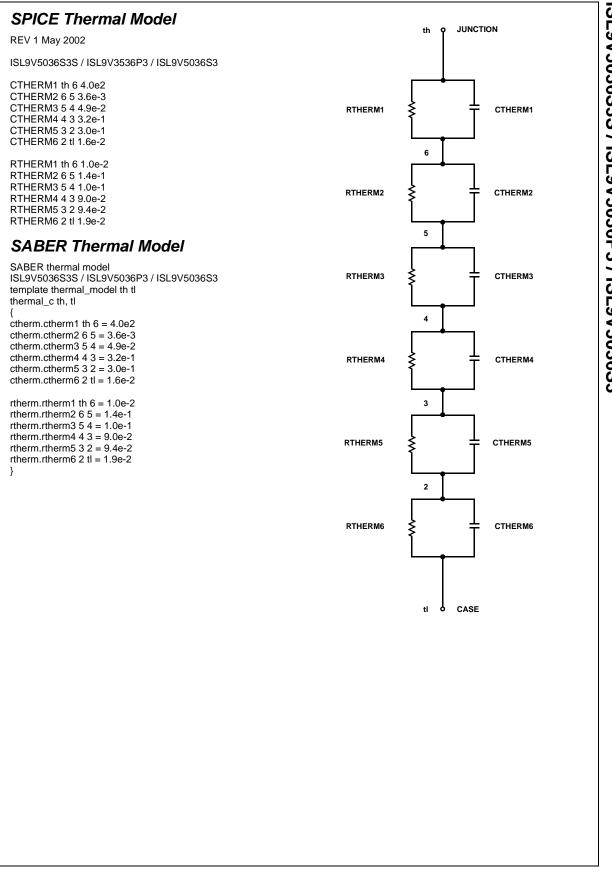
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